INTEGRATED CIRCUITS



Product specification

1990 Oct 04

IC15 Data Handbook







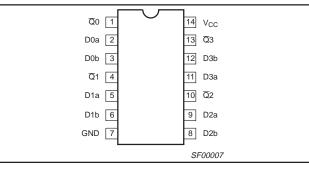
74F02

FEATURE

Industrial temperature range available (-40°C to +85°C)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F02	3.4ns	4.4mA

PIN CONFIGURATION



ORDERING INFORMATION

	C	RDER CODE		
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	INDUSTRIAL RANGE V _{CC} = 5V ±10%, T _{amb} = −40°C to +85°C	PKG DWG #	
14-pin plastic DIP	N74F02N	174F02N	SOT27-1	
14-pin plastic SO	N74F02D	I74F02D	SOT108-1	

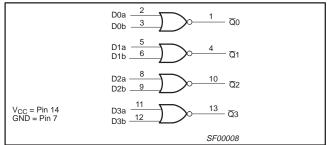
INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dna, Dnb	Data inputs	1.0/1.0	20µA/0.6mA
Qn	Data output	50/33	1.0mA/20mA

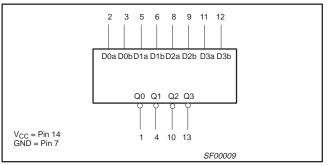
NOTE:

One (1.0) FAST unit load is defined as: $20\mu A$ in the high state and 0.6mA in the low state.

LOGIC DIAGRAM



LOGIC SYMBOL



FUNCTION TABLE

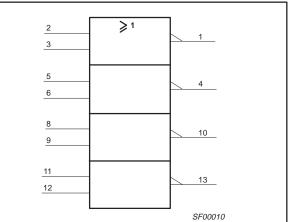
INP	JTS	OUTPUT
Dna	Dnb	Qn
L	L	Н
L	Н	L
Н	L	L
Н	Н	L

NOTES:

1 H = High voltage level

2 L = Low voltage level

IEC/IEEE SYMBOL



74F02

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device.

Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage		-0.5 to +7.0	V
I _{IN}	Input current		-30 to +5	mA
V _{OUT}	Voltage applied to output in high output state		–0.5 to V _{CC}	V
I _{OUT}	Current applied to output in low output state		40	mA
T _{amb}	Operating free air temperature range	Commercial range	0 to +70	°C
		Industrial range	-40 to +85	°C
T _{stg}	Storage temperature range		-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		UNIT			
			MIN	NOM	MAX	1
V _{CC}	Supply voltage		4.5	5.0	5.5	V
V _{IH}	High-level input voltage		2.0			V
VIL	Low-level input voltage				0.8	V
I _{lk}	Input clamp current				-18	mA
I _{OH}	High-level output current				-1	mA
I _{OL}	Low-level output current				20	mA
T _{amb}	Operating free air temperature range	Commercial range	0		+70	°C
		Industrial range	-40		+85	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIO	NS ¹			UNIT	
				MIN	TYP ²	MAX	1	
V _{OH}	High-level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}	2.5			V
			$V_{IH} = MIN, I_{OH} = MAX$	±5%V _{CC}	2.7	3.4		V
V _{OL}	Low-level output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V _{CC}		0.30	0.50	V
			$V_{IH} = MIN, I_{OI} = MAX$	±5%V _{CC}		0.30	0.50	V
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$	$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V
l	Input current at maximum voltage	input	$V_{CC} = MAX, V_I = 7.0V$				100	μA
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
IIL	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-0.6	mA
I _{OS}	Short-circuit output curren	ıt ³	V _{CC} = MAX	V _{CC} = MAX			-150	mA
I _{CC}	Supply current (total) ⁴	I _{CCH}	V _{CC} = MAX			3.0	5.6	mA
		I _{CCL}	V _{CC} = MAX		7.0	13.0	mA	

NOTES:

1 For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

2

All typical values are at $V_{CC} = 5V$, $T_{amb} = 25^{\circ}C$. Not more than one output should be shorted at a time. For testing I_{OS} , the use of high-speed test apparatus and/or sample-and-hold 3 techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

4 I_{CC} is measured with outputs open.

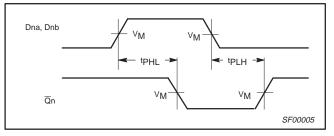
74F02

AC ELECTRICAL CHARACTERISTICS

						LIM	ITS			
SYMBOL	PARAMETER	TEST CONDITION	Tai	$V_{CC} = +5.0V$ $T_{amb} = +25^{\circ}C$ $C_{L} = 50pF, R_{L} = 500\Omega$			0V ± 10% C to +70°C R _L = 500Ω	V _{CC} = +5. T _{amb} = -40° C _L = 50pF,	UNIT	
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay Dna, Dnb to Qn	Waveform 1	2.5 2.0	4.4 3.2	5.5 4.3	2.5 2.0	6.5 5.3	2.5 1.5	7.0 6.0	ns

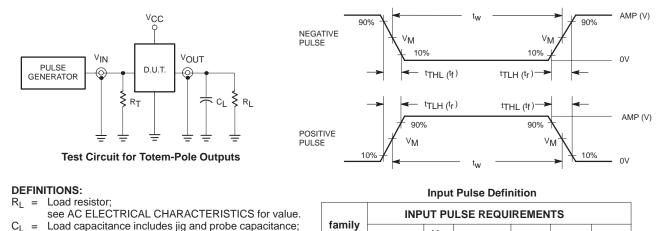
AC WAVEFORMS

For all waveforms, $V_M = 1.5V$.



Waveform 1. Propagation delay for inverting outputs

TEST CIRCUIT AND WAVEFORM



74F

 V_{M}

1.5V

rep. rate

1MHz

tw

500ns

t_{TLH}

2.5ns

t_{THL}

2.5ns

amplitude

3.0V

		See AC ELECTRICAL CHARACTERISTICS IOF value.
L	=	Load capacitance includes jig and probe capacitance;
		see AC ELECTRICAL CHARACTERISTICS for value.
		To provide the providence of a standard by a provide to 7 of

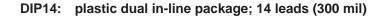
 R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

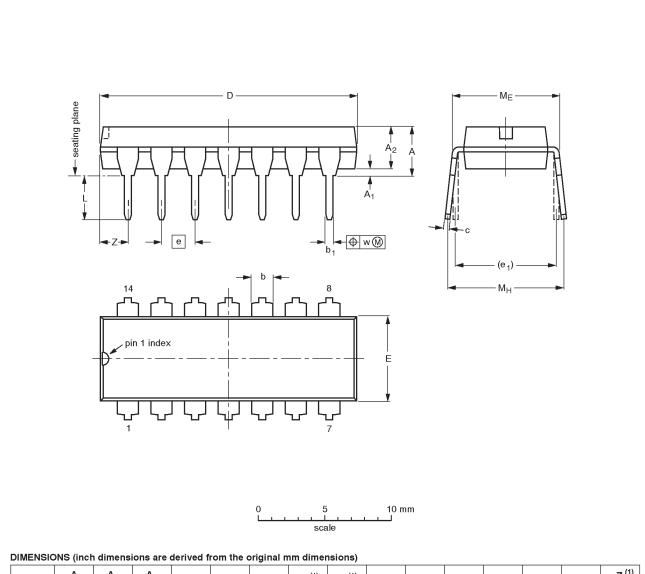
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Quad 2-input NOR gate





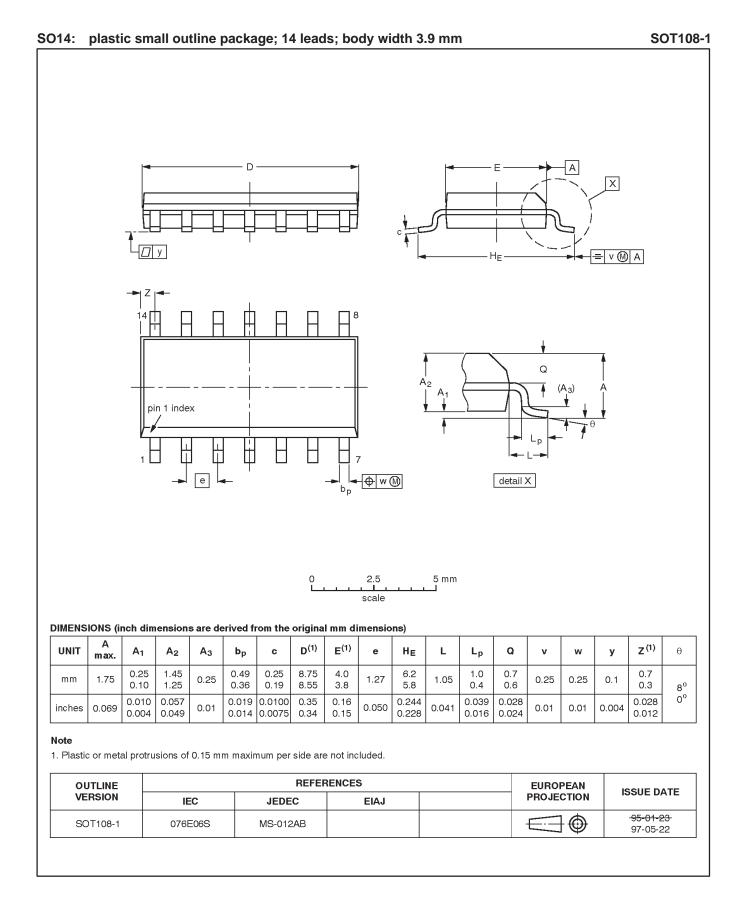
UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	ME	м _н	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES EUROPEAN				
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT27-1	050G04	MO-001AA				-92-11-17 95-03-11	

Product specification



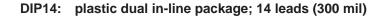
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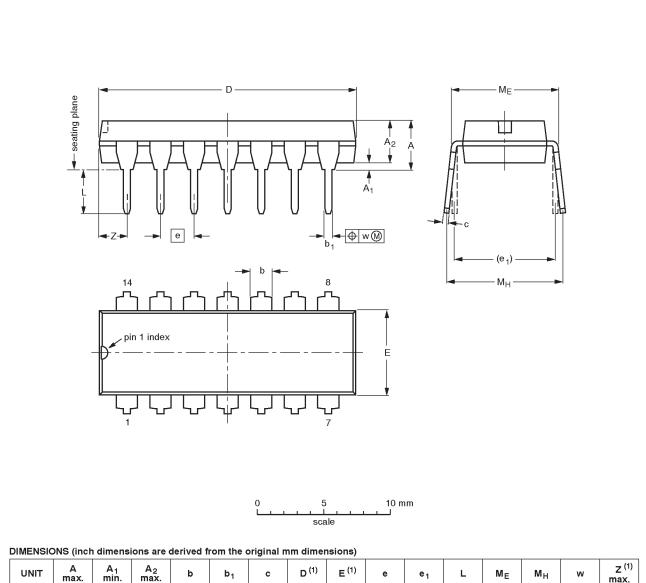
NOTES

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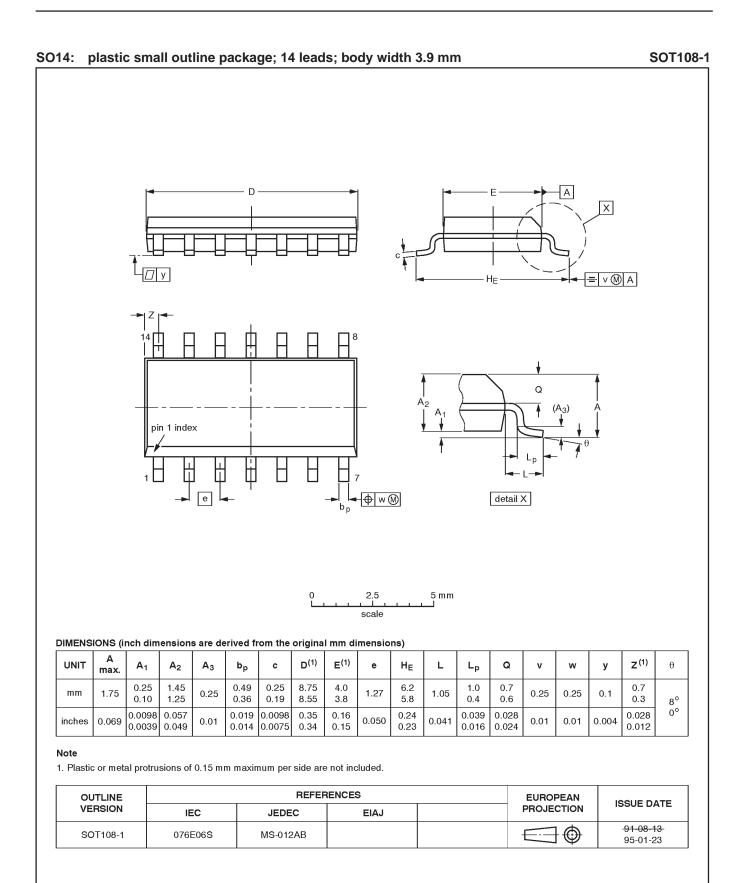
UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
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SOT27-1	050G04	MO-001AA				-92-11-17 95-03-11	

Product specification



74F02

NOTES

74F02

DEFINITIONS						
Data Sheet Identification	Product Status	Definition				
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.				
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.				
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